MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

ON Semiconductor®

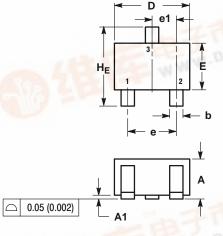


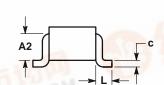


SC-70 (SOT-323) CASE 419-04 ISSUE M

DATE 27 MAY 2005

SCALE 4:1

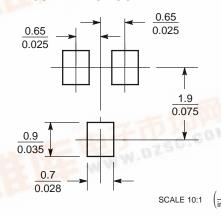




- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.7 REF 0.028 RE			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016
С	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
е	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
Ĺ	0.425 REF			0.017 REF		
HE	2.00	2.10	2.40	0.079	0.083	0.095

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM



= Specific Device Code M = Date Code

= Pb-Free Package

This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 5: PIN 1. ANODE

2. ANODE 3. CATHODE

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR
	E . 0750	

STYLE 9: PIN 1. ANODE STYLE 10: PIN 1. CATHODE STYLE 6: PIN 1. EMITTER STYLE 7: PIN 1. BASE STYLE 8: PIN 1. GATE 2. BASE 3. COLLECTOR 2. SOURCE 3. DRAIN 2. ANODE 3. ANODE-CATHODE EMITTER 2. CATHODE 3. COLLECTOR 3. CATHODE-ANODE



DOCUMENT NUMBER: 98ASB42819B STATUS: ON SEMICONDUCTOR STANDARD **NEW STANDARD:**

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SC-70 PAGE 1 OF 2

STYLE 4: PIN 1. CATHODE

2. CATHODE 3. ANODE

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0845B43810	R

PAGE 2 OF 2

ISSUE	REVISION	DATE				
M	ADDED NOMINAL VALUES AND UPDATED GENERIC MARKING DIAGRAM. REQ. BY HONG XIAO	27 MAY 2005				

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